

REMARKS

Reconsideration and reversal of the rejections expressed in the Office Action of May 12, 2008 are respectfully contended in view of the following remarks and the application as amended. The present invention relates to a heat transfer label with an electron beam cured surface, and to a method for producing the same.

Claims 1, 2, 6-8, 11, 12 and 14 were rejected under 35 U.S.C. §103(a) as being unpatentable over Hiatt et al., U.S. Patent No. 6,254,970 (Hiatt et al.). The Office Action states, inter alia, that Hiatt et al. teaches a clay coated paper as the substrate, and one of ordinary skill in the art would have been motivated to adjust the basis weight of the paper in order to ease transferrability of the transfer portion.

Hiatt et al. relates to a heat transfer label system, and is characterized in that it employs a carrier substrate and transfer release agent that minimizes or eliminates the transfer of the transfer release agent to the label during the process in which the label is affixed to a surface such as a package surface.

In order to enhance the prosecution of the present application, the claims have been further clarified by this Amendment and Response; Applicant again respectfully contends that Hiatt et al. provides no reasonable expectation that Applicant's invention as presently claimed would be successful. Hiatt et al. makes reference to its release agent at column 3, lines 64-67 – column 4, line 1, as follows: “... *the transfer release agent of the present invention comprises a layer having a thickness of approximately 0.3 to 0.5 mils. The resulting release agent typically provides approximately 0.5 to 1.0 pounds of wax per 6000 square feet of coated surface.*” (emphasis added) In contrast, the emulsion wax or other release material of the instant invention as presently claimed has a thickness of about 0.75 lbs. per 3,000 square feet, far outside the parameters taught in Hiatt et al. Indeed, the reference provides no reasonable expectation that such a value would be successful or desirable. Thus, this rejection is overcome.

For all of the above reasons, it is respectfully contended that the solicited claims define patentable subject matter. Reconsideration and reversal of the rejections expressed in

the Office Action of May 12, 2008 are respectfully requested. The Examiner is invited to call the undersigned if any questions arise during the course of reconsideration of this matter.

Respectfully submitted,

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/Richard A. Paikoff/
Richard A. Paikoff
Registration No. 34,892
Duane Morris LLP
30 South 17th Street
Philadelphia, PA 19103-4196
Telephone: 215-979-1853
mailto: rapaikoff@duanemorris.com

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